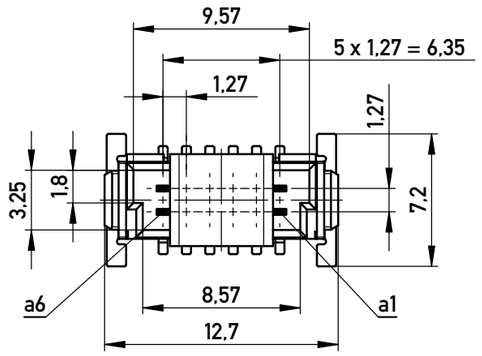
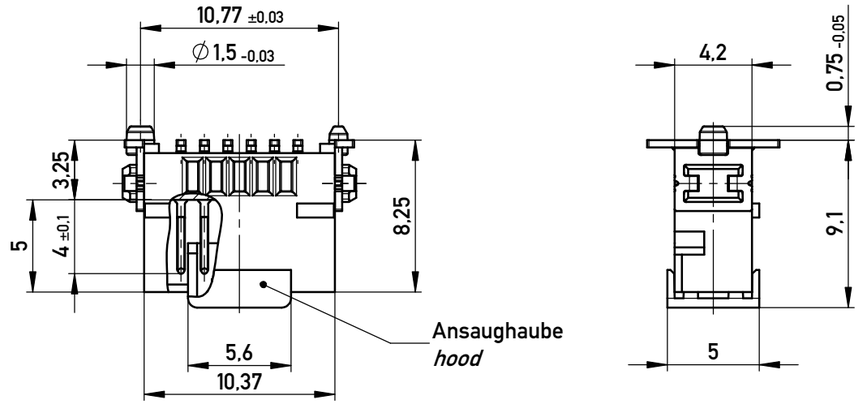






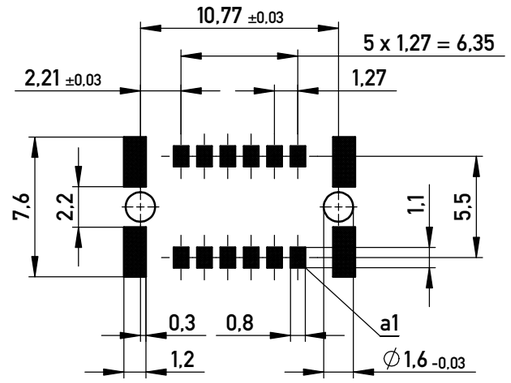
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

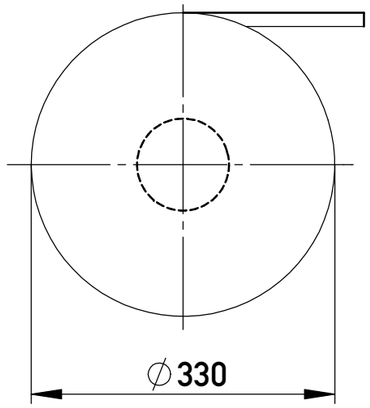
Anschlussbereich verzinnt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0,1 mm
Coplanarity Area of Termination ≤ 0,1 mm

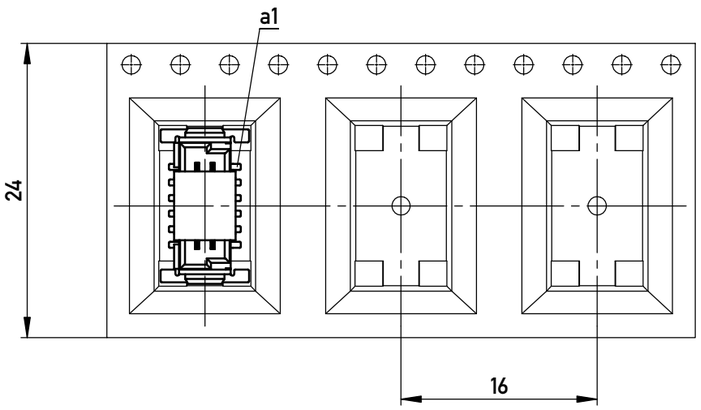
Leiterplatten-Layout Vorschlag für SMT
PCB-Layout Proposal for SMT



Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 280 Stück
Packaging unit: 280 pcs



Abspulrichtung - *Reel off Direction*



BA 8-03 - Standard Bauhöhe
type 8-03 - Standard Assembly Height

Information:	Tolerances	All Dimensions in mm	Scale 3:1
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d — 25.03.2014 — Index — Date	www.ERNI.com		100103510001 K A3
			Class SMCQ

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